SN74ALS992 9-BIT D-TYPE TRANSPARENT READ-BACK LATCH WITH 3-STATE OUTPUTS

SDAS028B – APRIL 1984 – REVISED JANUARY 1995

 3-State I/O-Type Read-Back Inputs Bus-Structured Pinout 	DW OR NT PACKAGE (TOP VIEW)			
True Logic Outputs		7 ₂₄] V _{CC}		
Designed With Nine Bits for Parity	1D [] 2	23] 1Q		
Applications	2D 🛛 3	22 2Q		
Package Options Include Plastic	3D 🛛 4	21] 3Q		
Small-Outline (DW) Packages and Standard	4D 🛛 5	20 🛛 4Q		
Plastic (NT) 300-mil DIPs	5D 🛛 6	19 🛛 5Q		
	6D 🛛 7	18 6Q		
description	7D 🛛 8	17 7Q		
This 9-bit latch is designed specifically for storing	8D 🛛 9	16 8Q		
the contents of the input data bus and providing	<u>9D</u> 10	15 <u>9Q</u>		
the capability of reading back the stored data onto	CLR 11	14 OEQ		
the input data bus. In addition, this device provides	GND [12	13 🛛 LE		
a 3-state buffer-type output and is easily				

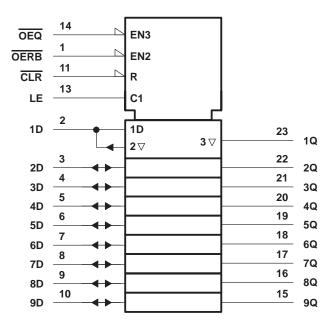
The nine latches are transparent D-type latches. While the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. The Q outputs are in the 3-state condition when the output-enable (OEQ) input is high.

Read back is provided through the output-enable (OERB) input. When OERB is taken low, the data present at the output of the data latches is allowed to pass back onto the input data bus. When OERB is taken high, the output of the data latches is isolated from the D inputs. OERB does not affect the internal operation of the latches; however, precautions should be taken not to create a bus conflict.

The SN74ALS992 is characterized for operation from 0°C to 70°C.

logic symbol[†]

implemented in parity applications.



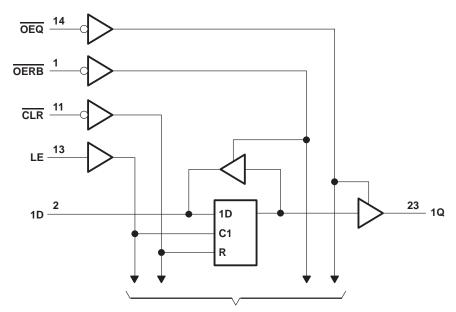
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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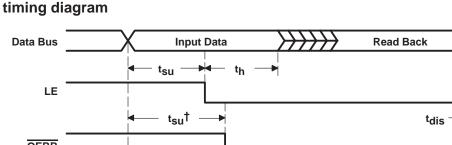
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logic diagram (positive logic)



To Eight Other Channels

Input Data



 \overrightarrow{OERB} $\overrightarrow{t_{gd}}$ $\overrightarrow{t_{pd}}$ $\overrightarrow{t_{pd}}$ $\overrightarrow{t_{pd}}$

 $\overline{\text{CLR}} = \text{H}, \overline{\text{OEQ}} = \text{L}$

[†] This setup time ensures that the read-back circuit will not create a conflict on the input data bus.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage, V _{CC}	
Input voltage, VI (OERB, OEQ, CLR, and LE)	
Voltage applied to D inputs and to disabled 3-state outputs	5.5 V
Operating free-air temperature range, T _A	0°C to 70°C
Storage temperature range	-65°C to 150°C

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



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recommended operating conditions

			MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V	
VIH	High-level input voltage	2			V	
VIL	Low-level input voltage			0.8	V	
ЮН	High level output ourrent	Q			-2.6	mA
	High-level output current	D			-0.4	шА
IOL		Q			24	mA
	Low-level output current	D			8	mA
t _w	Pulse duration	LE high	10			ns
		CLR low	10			115
t _{su}	Cature time	Data before LE↓	10			
	Setup time Data before OERB↓		10			ns
t _h	Hold time, data after LE \downarrow		5			ns
TA	Operating free-air temperature	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CON	DITIONS	MIN	MIN TYP [†] MAX		UNIT	
VIK		V _{CC} = 4.5 V,	l _l = –18 mA			-1.2	V	
	All outputs	V_{CC} = 4.5 V to 5.5 V,	I _{OH} = - 0.4 mA	V _{CC} -2	2		V	
VOH	Q	$V_{CC} = 4.5 V,$	$I_{OH} = -2.6 \text{ mA}$	2.4	3.2		V	
	D		I _{OL} = 4 mA		0.25	0.4	0.5 V	
Va	D	V _{CC} = 4.5 V	I _{OL} = 8 mA		0.35	0.5		
VOL		V _{CC} = 4.5 V	I _{OL} = 12 mA		0.25	0.4		
	Q	VCC = 4.5 V	I _{OL} = 24 mA		0.35	0.5		
IOZH	Q	V _{CC} = 5.5 V,	V _O = 2.7 V			20	μΑ	
IOZL	Q	V _{CC} = 5.5 V,	$V_{O} = 0.4 V$			-20	μA	
łį	D inputs	V _{CC} = 5.5 V	V _I = 5.5 V			0.1	mA	
	All others	VCC = 5.5 V	V _I = 7 V			0.1	ША	
. D inputs [‡]	D inputs‡	V _{CC} = 5.5 V,	V ₁ = 2.7 V			20		
IIH All others		vCC = 5.5 v,	V = 2.7 V			20	μA	
	D inputs [‡]					-0.1		
IIL All others		$V_{CC} = 5.5 V,$ $V_{I} = 0.4 V$				-0.1	mA	
IO§		V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	mA	
			Outputs high		30	50		
ICC	ICC	<u>V_{CC} =</u> 5.5 V, OERB high	Outputs low		50	80	mA	
		2 2 mgn	Outputs disabled		35	55		

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$. [‡] For I/O ports (Q_A thru Q_H), the parameters I_{IH} and I_{IL} include the off-state output current.

§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.



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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	ТО (OUTPUT)	$V_{CC} = 4.5$ $C_L = 50 \text{ pF}$ $T_A = \text{MIN to}$	UNIT	
			MIN	MAX	
^t PLH	D		3	14	ns
^t PHL	d	Q	4	16	
^t PLH	LE		6	20	200
^t PHL	LL	Q	8	25	ns
^t PHL		Q	6		
	CLR	D	8	8 26	ns
t _{en} ‡	0500		4	21	
t _{dis} §	OERB	D	2	14	ns
t _{en} ‡	OEQ	0	4	18	
t _{dis} §	UEQ	Q	1	14	ns

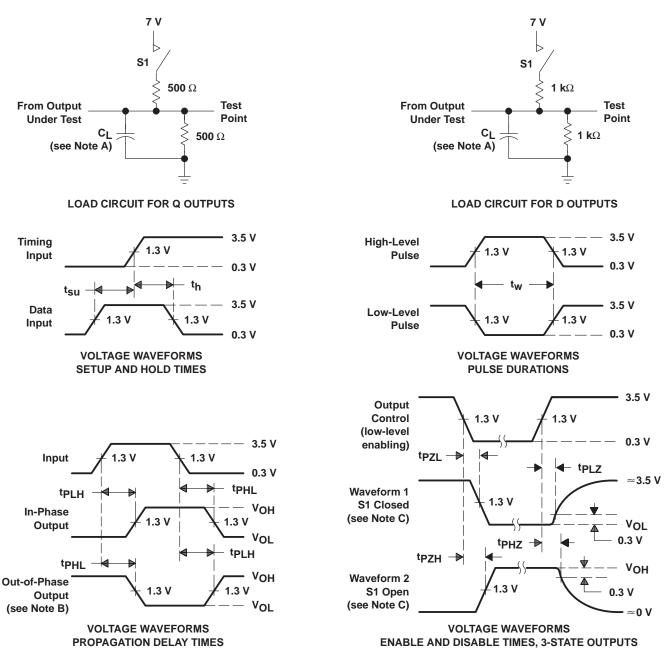
[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 $t_{en} = t_{PZH} \text{ or } t_{PZL}$ $t_{dis} = t_{PHZ} \text{ or } t_{PLZ}$

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- NOTES: A. CL includes probe and jig capacitance.
 - B. When measuring propagation delay times of 3-state outputs, switch S1 is open.
 - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_f = t_f = 2 ns, duty cycle = 50%.

Figure 1. Load Circuits and Voltage Waveforms





15-Oct-2015

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
SN74ALS992DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS992	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

15-Oct-2015

DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013 variation AD.



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